



MODEL NO. <u>BG12864BGPLDHp\$</u> <u>VER.01</u>

FOR MESSRS:

ON DATE OF:

APPROVED BY:

BOLYMIN, INC.

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### History of Version

Version	Contents	Date	Note
01	NEW VERSION	2018/10/11	SPEC.
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## 1. Numbering System

<u>B</u>	G	<u>12864</u>	<u>B</u>	<u>G</u>	<u>P</u>	L	D	H	<u>p\$</u>
0	1	2	3	4	5	6	7	8	9

0	Brand	Bolymin	
1	Module Type	C= character type G= graphic type P= TAB/TCP type	O= COG type F= COF type L=PLED/OLED
2	Format	2002=20 characters, 2 lines 12232= 122 x 32 dots	
3	Version No.	B type	
4	LCD Color	G=STN/gray Y=STN/yellow-green PLED/yellow-green C=color STN,OLED/RGB	B=STN/blue,OLED/blue F=FSTN T=TN
5	LCD Type	R=positive/reflective P=positive/transflective	M=positive/transmissive N=negative/transmissive
6	Backlight type/color	L=LED array/ yellow-green H=LED edge/white R=LED array/red G=LED edge/yellow-green F=RGB array I=RGB edge Q=LED edge/red N=No backlight	D=LED edge/blue E=EL/white B=EL/blue C=CCFL/white Y=LED Bottom/yellow O=LED array/orange K=LED edge/green A=LED edge/amber
7	CGRAM Font (applied only on character type)	J=English/Japanese Font E=English/European Font G=Chinese(simple) F=Chinese(traditional) Z= Chinese(simple)+Chinese (traditional)	C=English/Cyrillic Font H=English/Hebrew Font A=English/Arabic Font D=English+Japanese+ Chinese(simple)+Chinese (traditional) Font
8	View Angle/ Operating Temperature	B=Bottom/Normal Temperature H=Bottom/Wide Temperature U=Bottom/Ultra wide Temperature	T=Top/Normal Temperature W=Top/Wide Temperature C=9H/Normal Temperature E=Top/ultra wide temperature
9	Special Code	3=3.3 volt logic power supply n=negative voltage for LCD c=cable/connector	t=temperature compensation for LCD p=touch panel \$=RoHS

### 2. Handling Precaution

### 2.1 Precaution in use of LCD Module

- 2.1.1. LCD panel is made of glass. Avoid excessive mechanical shock or applying strong pressure and/or sharp tools on the surface of display area.
- 2.1.2. The polarizer placed on the display surface is easily scratched and damaged. Extreme care should be taken when handling it. To clean dust or dirt off the display surface, wipe gently with cotton, or other soft material soaked with isopropyl alcohol, ethyl alcohol, do not use water, ketone or aromatics to clear display surface, and never scrub it hard.
- 2.1.3. Keep LCD panels away from direct sunlight. The storage environment should be dust-free, clean, dry, temperature is 25°C ±10°C and the humidity is below 55% RH.
- 2.1.4. Do not input any signal before power is turned on.
- 2.1.5. Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels and also cause rainbow on the display.
- 2.1.6. It's important to control soldering temperature and time. RoHS compliant materials might need higher temperature and time, but try to keep temperature under 350°C and time in 3-5 sec.
- 2.1.7. EL is manufactured from the organic film, and is easily affected by temperature, humidity and other environmental impact. Long time storage might cause low quality of the case. Therefore, please start production in 3 months after reception of the LCM. If in any case, long time storage over 3 months is necessary, please keep EL in vacuum package or at least in humidity < 35% RH, and temperature 25°C±10°C. Note: 2.1.7. is applied to EL backlight only.</p>

### 2.2 Static Electricity Precautions:

- 2.2.1. The LCD module contains a C-MOS LSI. People who operate the LCM should wear ESD protection equipment to prevent ESD hurt on products.
- 2.2.2. Do not touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.
- 2.2.3. Do not touch the connection terminals of the display with bare hand; it will cause disconnection or defective insulation of terminals.
- 2.2.4. The modules should be kept in anti-static bags or trays for storage.
- 2.2.5. Only properly grounded soldering irons should be used.
- 2.2.6. If an electric screwdriver is used, it should be grounded and shielded to prevent sparks.
- 2.2.7. The normal static prevention measures should be observed for work clothes and working benches.
- 2.2.8. Since dry air(almost low RH) is inductive to static, a humidity of 50-60% RH is recommended in assembly line.

### 2.3 Operation Precautions:

- 2.3.1. DC voltage applied on LCM causes electrochemical reactions, which will deteriorate the display over time. The applied pulse waveform should be a symmetric waveform such that no DC component remains. Be sure to use the specified operating voltage.
- 2.3.2. LCD driving voltage should be kept within specified range; excess voltage will shorten display life, while less voltage may not turn on LCM.
- 2.3.3. LCM response time will be extremely delayed in low operating temperature(such as -20 °C) than in room operating temperature. Therefore, higher LCD driving voltage is required in low operating temperature; On the other hand, in high operating temperature (such as +70°C) LCD shows dark background color, therefore lower LCD driving voltage is required. Be sure to use the specified LCD driving voltage in different operating temperature.

2.4 Safety:

2.4.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin. If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

### 2.5 WARRANTY POLICY

Bolymin .Will provide one-year warranty for the products only if under specification operating conditions.

If there are functional defects found during the period of warranty, the defective products would be replaced on a one-to-one basis.

Bolymin would not be responsible for any direct/indirect liabilities consequential to any parties.

### 2.6 MTBF

- 2.6.1 .By specific test condition, MTBF based on  $30^\circ$ C normal operation temperature is 50,000hours.
- 2.6.2 Test Condition:

2.6.2.1 Supply Voltage for LCM: Typical Vdd

- 2.6.2.2 CC (Constant Current) mode and typical current is applied for LED.
- 2.6.2.3 Run-Patterns: by Bolymin's test program that has defined patterns and cyclic period.
- 2.6.2.4 Humidity: 60%RH

#### 2.6.3 Test Criteria:

Attenuation of average brightness:  $\leq$  50%

Increasing of current consumption for LCM/Backlight:  $\leq$  20%

Display function at room temperature: Normal

Appearance: Normal



### 3. General Specification

(1) Mechanical Dimension

Item	Standard Value	Unit
Number of dots	128 x 64	dots
Module dimension (L*W*H)	93.0(W)*70.0(H)*14.6(T)	mm
View area	72.0(W)×40.0(H)	mm
Active area	66.52(W)×33.24(H)	mm
Dot size	0.48(W)×0.48(H)	mm
Dot pitch	0.52(W)×0.52(H)	mm

(2)Controller IC: ST7920

# **4. Absolute Maximum Rating** 4.1 Electrical Absolute Maximum Ratings

(Vss=0V, Ta=25℃)

Parameter	Symbol	Min	Max	Unit
Logic Circuit Supply Voltage	VDD	-0.3	6.0	V
LCD Driving Voltage	VO	-0.3	7.0	V
Input Voltage	VI	-0.3	VDD	V

### 4.2 Environmental Absolute Maximum Ratings

Item	Symbol	Min	Max	Unit	Note
Operating Temperature	TOP	-20	70	°C	(1)
Storage Temperature	TST	-30	80	°C	(1)

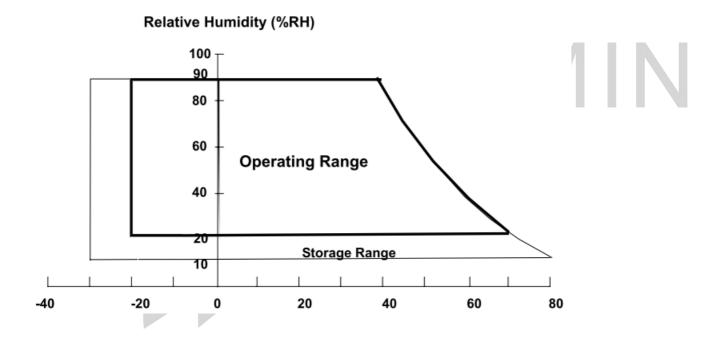
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Note (1)

(a) 90 %RH Max. (Ta <= 40 °C).

(b) Wet-bulb temperature should be 39 °C Max. (Ta > 40 °C).

(c) No condensation.





### **5. Electrical Characteristics**

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$		_	5.0	—	V
Supply Voltage For LCD	V <sub>O</sub> -V <sub>SS</sub>	Ta=25°C	4.2	4.5	4.8	v
Input High Vol	$V_{\mathrm{IH}}$	_	$0.7 V_{DD}$	_	V <sub>DD</sub>	V
Input Low Vol	V <sub>IL</sub>		-0.3	_	0.6	V
Output High Vol	V <sub>OH</sub>		$0.8 \ V_{DD}$	_	V <sub>DD</sub>	V
Output Low Vol.	V <sub>OL</sub>	_	_	_	0.1	V
Supply Current	I <sub>DD</sub>	_	_	2.5	_	mA
LCM Surface Luminance Ta=25°C	L	I <sub>LED</sub> =330mA Display all OFF	16	24		cd/m <sup>2</sup>

\*Optimum LCD driving voltage value, referring to above mentioned range, is changed due to

different batch of LCD glass.



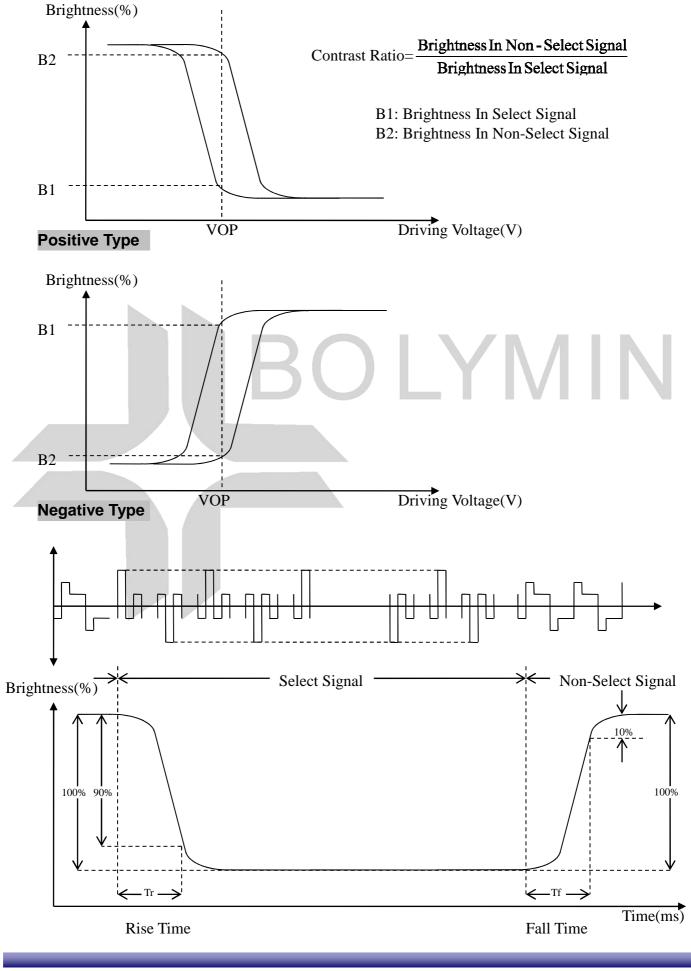
## 6. Optical Characteristics

a. STN

(Ta= $25^{\circ}$ C)

Item	Symbol	Min.	Тур.	Max.	Unit
	heta f	-	43	-	deg
	heta b	-	45	-	deg
View Angle (CR>=2)	φL	-	39	-	deg
	arphi r	-	42	-	deg
Contrast Ratio	CR	2	3	-	-
Response Time $25^{\circ}$ C	T rise	-	200	350	ms
Response Time 25 C	T fall	-	200	400	ms
9H 9H	$(\theta = 0^{\circ})$ $\theta_{\rm B}$ $\theta_{\rm R}$		2Н		3Н





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### 7. Interface Pin Function

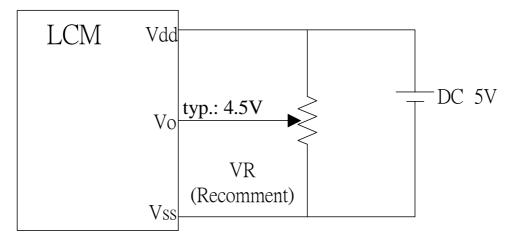
1	1		
Pin No.	Symbol	Level	Description
1	Vss	0V	Ground
2	Vdd	V+	Supply Voltage for logic(5.0V)
3	Vo	(Variable)	Operating voltage for LCD
4	RS	H/L	H:DATA, L:Instruction code
5	R/W	H/L	H:Read(MPU→Module)L:Write(MPU→Module)
6	E	H,H→L	Chip enable signal
7	DB0	H/L	Data bit 0
8	DB1	H/L	Data bit 1
9	DB2	H/L	Data bit 2
10	DB3	H/L	Data bit 3
11	DB4	H/L	Data bit 4
12	DB5	H/L	Data bit 5
13	DB6	H/L	Data bit 6
14	DB7	H/L	Data bit 7
15	A	_	Power supply for LED backlight ( + )
16	К	_	Power supply for LED backlight ( - )
17	REST	H/L	Reset LCM
18	Vee	_	No connect.
L			1

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### 8. Power supply for LCD Module and LCD operating voltage adjustment

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LCM operating on "VDD=5.0V"(Not recommend to use positive voltage when VDD=5.0V)



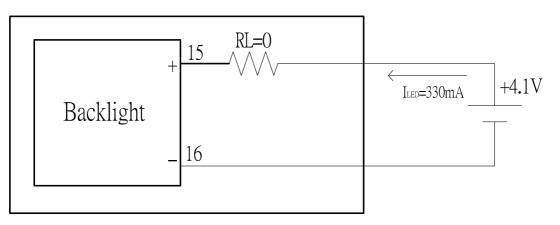
### 9. Backlight information

(1)LED array / yellow-green						
Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Supply Current	ILED	_	330	_	mA	VLED=4.1V
Supply Voltage	V	_	4.1	4.4	V	ILED=330mA
Reverse Voltage	VR	-	-	5	V	
Wave Length	λр	568	_	573	nm	ILED=210mA
Color		Yellow Green				

#### 9.2 Backlight driving methods

a. LED B/L drive from pin15 (LED+) pin16 (LED-) a.1 array/yellow-green

### LCM



### **10. Quality Assurance**

#### 10.1 Inspection conditions

- 1. The LCD shall be inspected under 20~40W white fluorescent light.
- 2. Checking Direction shall be in the 40 degree from perpendicular line of specimen surface.

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- 3. Checker shall see over 30 cm.
- 4. Inspect about 5 seconds for each side.
- 5. Defect that is located at outside of VA and doesn't affect function is ignored.

#### 10.2 Inspection Parameters

NO.	Parameter	Criteria					
1	Black or White spots	$\begin{array}{c c} Dimension & N \\ \hline D \leq 0.10 & Dis \\ \hline 0.10 < D \leq 0.2 & \\ \hline 0.2 < D \leq 0.3 & \\ \end{array}$		cceptable Number Disregard 4 2	Class Of Defects Minor	Acceptable Level 2.5	ΙΝ
	(Particle)		+ Short)/2				
					d 5/module e of AA and	doesn't affect fo	unction is
		Zone X(mm) Y(mm)		Acceptabl			•
		— —	0.05≧W	Disregare	k		_
	Caratab	4.0≧L	 0.05≧W	4			
2	Scratch, Substances	3.0≧L	0.1≧W	2	— Minor	2.5	
		—	0.1 <w< td=""><td>0</td><td></td><td></td><td></td></w<>	0			
			ects should	d not excee	d 5/module e of AA and	doesn't affect f	unction is

3	Air Bubbles ( between glass & polarizer)	Zone DimensionAcceptable NumberClass Of DefectsAcceptable Level $D \leq 0.2$ Disregard 0.2 < D $\leq 0.5$ $3$ Minor2.5 $0.5 < D$ 002.5Total defects shall not excess 3/module.Defect that is located at outside of AA and doesn't affect function is ignored.Bobble is sawn only under reflection light is disregarded.
4	Displaying	1. Incomplete or broken line is not allowed. 2. Pinholes $ \begin{array}{c c c c c c c c c c c c c c c c c c c $
	Pattern	3. Deformation $ \frac{1}{1} + \frac{1}{1}$

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Other Inspection standard reference Bolymin standard.

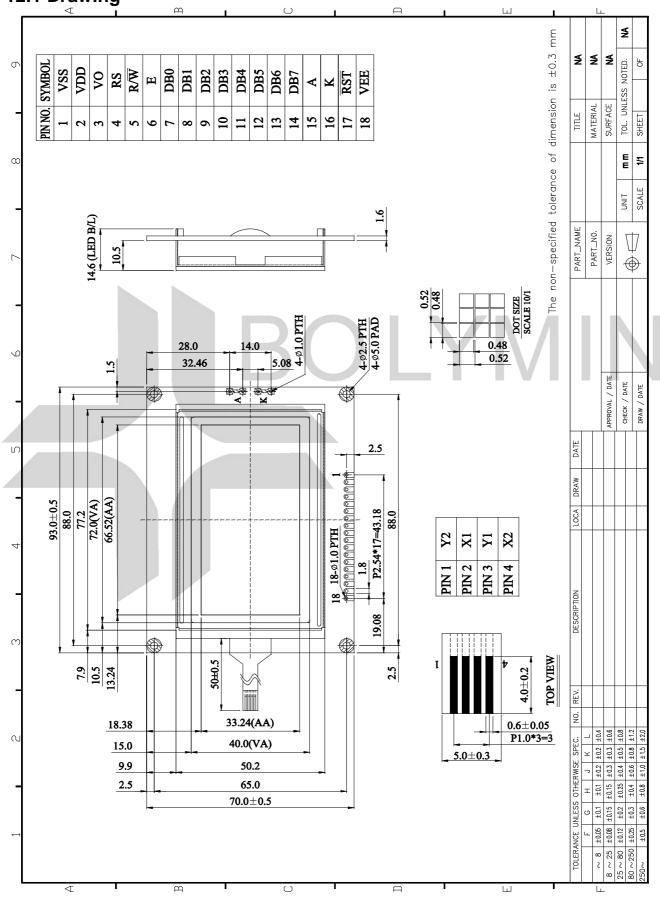


### 11. Reliability ■Content of Reliability Test

Envi	ronmental Test			
No	Test Item	Content of Test	Test Condition	Applicable Standard
1	High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 96 hrs	
2	Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30℃ 96 hrs	
3	High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 96 hrs	
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 96 hrs	A
5	Humidity Test	Endurance test applying the high humidity storage for a long time.	40℃,90%RH 96hrs	_
6	Temperature cycle (Non-operation)	Endurance test applying the low and high temperature cycle. -30°C 80°C → 30min 30min 1 cycle	-30℃/80℃ 10 cycles	
7	Vibration test	Endurance test applying the vibration during transportation and using.	Total Fixed Amplitude:1.5mm Vibration Frequency :10~55Hz One cycle 60 seconds to 3 direction of X,Y,Z for each 15minutes	

%Assess after placing at normal temperature and humidity for 4 hour  $\circ$  No abnormalities in functions and appearance  $\circ$ 

### 12. Appendix (Drawing ,ST7920 controller data) 12.1 Drawing



### 12.2 ST7920 controller data

Function Description :

#### System interface

ST7920 supports 3 kinds of bus interface to MPU. 8 bits parallel, 4 bits parallel and clock synchronized serial interface. Parallel interface is selected by PSB="I" and serial interface by PSB="0". 8 bit / 4 bit interface is selected by function set instruction DL bit.

Two 8 bit registers (data register DR, instruction register IR) are used in ST7920's write and read operation. Data Register (DR) can access DDRAM/CGRAM/GDRAM and IRAM's data through the address pointer implemented by Address Counter (AC). Instruction Register (IR) stores the instruction by MPU to ST7920.

4 modes of read/write operation specified by RS and RW :

RS	RW	description	
L	L	MPU write instruction to instruction register (IR)	
L	Н	MPU read busy flag (BF) and address counter (AC)	
Н	L	MPU write data to data register (DR)	
Н	Н	MPU read data from data register (DR)	

### Busy Flag (BF)

Internal operation is in progress when BF="I", ST7920 is in busy state. No new instruction will be accepted until BF="0". MPU must check BF to determine whether the internal operation is finished and new instruction can be sent.

### Address counter (AC)

Address counter( AC ) is used for address pointer of DDRAM/CGRAM/IRAM/GDRAM. (AC) can be set by instruction and after data read or write to the memories (AC) will increase or decrease by 1 according to the setting in "entry mode set". When RS="0" and RW= "1" and E="1" the value of (AC) will output to DB6~DB0.

#### 16x16 character generation ROM (CGROM) and 8x16 half height ROM (HCGROM)

ST7920 provides character generation ROM supporting 8192 16 x 16 character fonts and 126 8 x 16 alphanumeric characters. It is easy to support multi languages application such as Chinese and English. Two consecutive bytes are used to specify one 16x16 character or two 8x16 half-height characters. Character codes are written into DDRAM and the corresponding fonts are mapped from CGROM or HCGROM to the display drivers.

#### Character generation RAM (CGRAM)

ST7920 provides RAM to support user-defined fonts. Four sets of 16x16 bit map area are available. These user-defined fonts are displayed the same ways as CGROM fonts through writing character cod data to DDRAM



#### ICON RAM (IRAM)

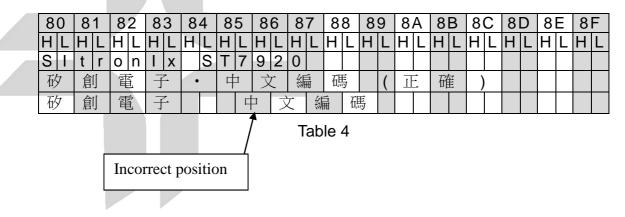
ST7920 provides 240 ICON display. It consists of 15 sets of IRAM address. Each IRAM address has 16 bits data IRAM address should be set first before writing to the IRAM. Two bytes for each address. First higher byte (D15~D8) and then lower byte (D7~D0).

#### Display data RAM (DDRAM)

There are 64x2 bytes for display data RAM area. Can store display data for 16 characters(16x16) by 4 lines or 32characters(8x16) by 4 lines. However, only 2 lines can be displayed at a time. Character codes stored in DDRAM point to the fonts specified by CGROM, HCGROM and CGRAM. ST7920 display half height HCGROM fonts, user-defined CGRAM fonts and full 16x16 CGROM fonts. Data codes 0000H~0006H are for CGRAM user-defined fonts. Data codes 02H~7FH are for half height alpha numeric fonts. Data codes (A140--~D75F) are for BIG5 code and (A1A0~F7FF) are for GB code.

- 1. Display HCGROM fonts: Write 2 bytes data to DDRAM to display two 8x16 fonts. Each byte represents 1character font. The data of each byte is 02H~7FH.
- 2. Display CGRAM fonts: Write 2 bytes data to DDRAM to display one 16x16 font. Only 0000H, 0002H,0004H,0006H are allowed.
- 3. Display CGROM fonts: Write 2 bytes data to DDRAM to display one 16x16 font.A140H~D75FH are for (BIG5) code,A1A0H~F7FFH are for (GB) code.

Higher byte (D15--, D8) are written first and then lower byte (D7~DO). Refer to Table 5 for address map CGRAM fonts and CGROM fonts can only be displayed in the start position of each address. (Refer to Table 4)



#### Graphic RAM (GDRAM)

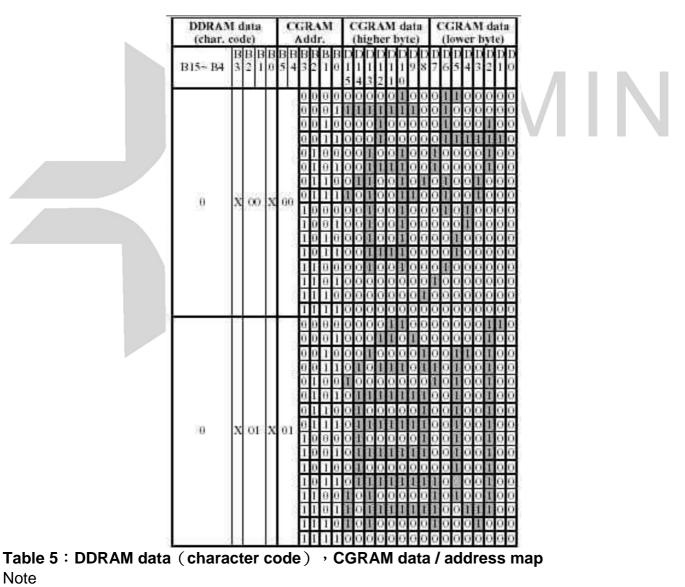
Graphic display RAM supports 64x256 bits bit-mapped memory space. GDRAM address is set by writing 2consecutive bytes for vertical address and horizontal address. Two-bytes data write to GDRAM for one address. Address counter will automatically increase by one for the next two-byte data. The procedure is as followings.

- 1. Set vertical address (Y) for GDRAM
- 2. Set horizontal address (X) for GDRAM
- 3. Write D 15~ D8 to GDRAM(first byte)
- 4. Write D7~D0 to GDRAM(second byte)

Graphic display memory map please refer to Table-8

#### LCD driver

LCD driver have 33 common and 64 segments to drive the LCD panel. Segment data from CGRAM /CGROM/HCGROM are shifted into the 64 bits segment latches to display. Extended segment driver ST7921 can be used to extend the segment drivers to 256.



1. DDRAM data (character code) bit1 and bit2 are the same as CGRAM address bit4 and bit5.

- 2. CGRAM address bit0 to bit3 specify total 16 rows. Row16 is for cursor display. The data in row 16 will be logical OR to the cursor.
- 3. CGRAM data for each address is 16 bits.
- 4. DDRAM data to select CGRAM bit4 to bit15 must be "0". Bit0 and bit3 value are "don't care".

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ICON addr		A								ICC	ON RAM data								
Set S set IF	SR "0"	addre																	
AC3	AC2	AC1	AC 0	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	0	0	0	SEG0	SEG1	SEG2	SEG3	SEG4	SEG5	SEG6	SEG7	SEG8	SEG9	SEG10	SEG11	SEG12	SEG13	SEG14	SEG15
0	0	0	1	SEG16	SEG17	SEG18	SEG19	SEG20	SEG21	SEG22	SEG23	SEG24	SEG25	SEG26	SEG27	SEG28	SEG29	SEG30	SEG31
0	0	1	0	SEG32	SEG33	SEG34	SEG35	SEG36	SEG37	SEG38	SEG39	SEG40	SEG41	SEG42	SEG43	SEG44	SEG45	SEG46	SEG47
0	0	1	1	SEG48	SEG49	SEG50	SEG51	SEG52	SEG53	SEG54	SEG55	SEG56	SEG57	SEG58	SEG59	SEG60	SEG61	SEG62	SEG63
0	1	0	0	SEG64	SEG65	SEG66	SEG67	SEG68	SEG69	SEG70	SEG71	SEG72	SEG73	SEG74	SEG75	SEG76	SEG77	SEG78	SEG79
0	1	0	1	SEG80	SEG81	SEG82	SEG83	SEG84	SEG85	SEG86	SEG87	SEG88	SEG89	SEG90	SEG91	SEG92	SEG93	SEG94	SEG95
0	1	1	0	SEG96	SEG97	SEG98	SEG99	SEG10 0	SEG10	SEG10 2	SEG10 3	SEG10 4	SEG10 5	SEG10 6	SEG10 7	SEG10 8	SEG10 9	SEG11 0	SEG111
0	1	1	1	SEG112	SEG11 3	SEG11	SEG11 5	-	SEG11	SEG11 8	SEG11 9		SEG12			SEG12			SEG12
1	0	0	0	SEG128	SEG12			SEG13			SEG13			SEG13	SEG13			SEG14	SEG14
1	0	0	1	SEG144	9 SEG14	-	SEG14			SEG15	5 SEG15		7 SEG15		9 SEG15		SEG15		3 SEG15
1	0	1	0	SEG160	5 SEG16			8 SEG16		0 SEG16		2 SEG16			5 SEG17	6 SEG17		8 SEG17	9 SEG17
1	0	1	1	SEG176	1 SEG17	2 SEG17	3 SEG17		5 SEG18	6 SEG18	7 SEG18	8 SEG18	9 SEG18	0 SEG18	1 SEG18				5 SEG19
1	1	0	0	SEG192	7 SEG19	8 SEG19	9 SEG19	0 SEG19	1 SEG19	2 SEG19	3 SEG19	4 SEG20	5 SEG20	6 SEG20	7 SEG20	8 SEG20	9 SEG20	0 SEG20	1 SEG20
1	1	0	1	SEG208	3 SEG20	4 SEG21	5 SEG21	6 SEG21	7 SEG21	8 SEG21	9 SEG21	0 SEG21	1 SEG21	2 SEG21	3 SEG21	4 SEG22	5 SEG22	6 SEG22	7 SEG22
1	1	1	0	SEG224	9 SEG22	0 SEG22	1 SEG22	2 SEG22	3 SEG22	4 SEG23	5 SEG23	6 SEG23	7 SEG23	8 SEG23	9 SEG23	0 SEG23	1 SEG23	2 SEG23	3 SEG23
		-	0		5	6	7	8	9	0	1	2	3	4	5	6	7	8	9
1	l Tabl			NRAM	laddi	2200	data	anda	am	ont n	ine								
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Table 6 16x8 half-height characters

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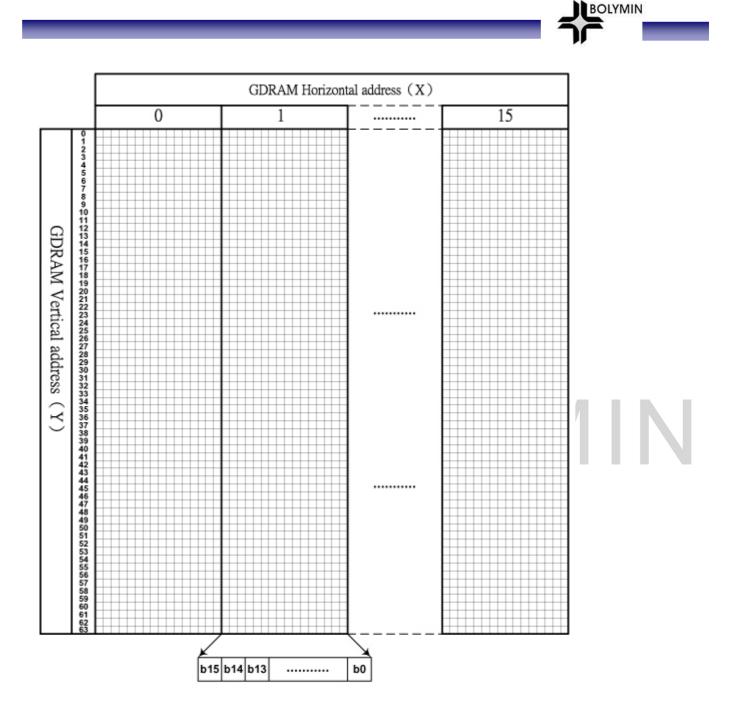


Table 8 GDRAM display coordinates and corresponding address



### Instructions

ST7920 offers basic instruction set and extended instruction set:

Ins	code										Description	Exec time
ins	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		(540KHZ)
CLEAR	0	0	0	0	0	0	0	0	0	1	Fill DDRAM with "20H", and set DDRAM address counter (AC) to "00H"	1.6 ms
HOME	0	0	0	0	0	0	0	0	1	x	Set DDRAM address counter (AC) to "00H", and put cursor to origin; to content of DDRAM are not changed.	72 us
ENTRY MODE	0	0	0	0	0	0	0	1	I/D	S	Set cursor position and shift when doing write or read operation.	72 us
DISPLAY ON/OFF	0	0	0	0	0	0	1	D	с	В	D=1:display ON C=1:cursor ON B=1:blink ON	72 us
CURSOR DISPLAY CONTROL	0	0	0	0	0	1	S/C	R/L	x	х	Cursor position and display shift control ; the content of DDRAM are not changed.	72 us
FUNCTIO N SET	0	0	0	0	1	DL	x	0 RE	x	x	DL=1 8-BIT interface DL=0 4-BIT interface RE=1 : extended instruction RE=0 : basic instruction	72 us
SET CGRAM ADDR.	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address to address counter (AC) <u>Make sure that in extended</u> <u>instruction SR=0 (scroll or RAM</u> address select)	72 us
SET DDRAM ADDR.	0	0	1	0 AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address to address counter(AC) AC6 is fixed to 0	72 us
READ BUSY FLAG(BF) & ADDR.	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Read out the value of address counter(AC)	0 us
WRITE RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data to internal RAM (DDRAM/CGRAM/IRAM/GDRAM )	72 us
READ RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM/IRAM/GDRAM )	72 us



#### Instruction set 2 : (RE=1 : Extended instruction)

Inc					CO	de					Description	Exec time
Ins	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		(540KHZ)
STAND BY	0	0	0	0	0	0	0	0	0	1	Enter stand by mode, any other instruction can terminate (Com132 halted, only Com33 ICON can display)	72 us
SCROLL or RAM ADDR. SELECT	0	0	0	0	0	0	0	0	1	SR	SR=1 : enable vertical scroll position SR=0 : enable IRAM address <u>(extended instruction)</u> SR=0 : enable CGRAM address (basic instruction)	72 us
REVERSE	0	0	0	0	0	0	0	1	R1	R0	Select 1 out of 4 line (in DDRAM) and decide whether to reverse the display by toggling this instruction. <b>R1, R0 initial value is 00</b>	72 us
SLEEP	0	0	0	0	0	0	1	SL	х	х	SL=1 : leave sleep mode SL=0 : enter sleep mode	72 us
EXTENDED FUNCTION SET	0	0	0	0	1	DL	x	1 RE	G	0	DL=18-BIT interfaceDL=04-BIT interface <b>RE=1</b> : extended instruction <b>RE=0</b> : basic instructionG=1 : graphic display ONG=0 : graphic display OFF	72 us
SET IRAM or SCROLL ADDR	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	SR=1 : AC5~AC0 the address of vertical scroll SR=0 : AC3~AC0 the address of ICON RAM	72 us
SET GRAPHIC RAM ADDR.	0	0	1	0 AC6	0 AC5	0 AC4	AC3 AC3		AC1 AC1		Set CGRAM address to address counter (AC) First set vertical address and the horizontal address by consecutive writing. Vertical address range AC6AC0 Horizontal address range AC3AC0	72 us

Note :

- 1. Make sure that ST7920 is not in busy state by reading the busy flag before sending instruction or data. If use delay loop instead please make sure the delay time is enough. Please refer to the instruction execution time.
- 2. "RE" is the selection bit of basic and extended instruction set. Each time when altering the value of RE it will remain. There is no need to set RE every time when using the same group of instruction set.



### Initial setting(Register flag) (RE=0: basic instruction)

Ins	COC	de				3/ (					Description			
	RS	RW	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0				
ENTRY			Cursor move to right, DDRAM address counter (AC)											
MODE SET									1	0	plus 1			
DISPLAY	0	0	0	0	0	0	1	D	С	В	Display, cursor and blink ALL OFF			
STATUS								0	0	0	Display, cursor and blink ALE OF			
CURSOR DISPLAY	0	0	0	0	0	1	S/C	R/L	х	х	No cursor or display shift operation			
SHIFT							x	x			No cursor or display shift operation			
FUNCTION	0	0	0	0	1	DL	х	0 RE	х	х	x 8 BIT MPU interface, basic instruction se			
SET						1		0			<b>O BIT</b> WIF O Interface, basic instruction set			

						1		U			
Initial set	ting	J(Re	egis	ster	fla	g) (	RE	=1	: ex	ter	ided instruction set)
Ins	coc	de	5							_	Description
	RS	RW	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0	
SCROLL OR RAM	0	0	0	0	0	0	0	1	1	SR	Allow IDAM address or set CCDAM address
ADDR. SELECT										0	Allow IRAM address or set CGRAM address
	0	0	0	0	0	0	0	1	R1	R0	
REVERSE									0	0	Begin with normal and toggle to reverse
	0	0	0	0	0	0	1	SL	х	х	Not in close mode
SLEEP								1			Not in sleep mode
EXTENDED FUNCTION	0										
SET									0	Graphic display OFF	

#### **Description of basic instruction set**

• CLEAR

code

RS RW DB7 DB6 DB5 DB4 DB3 DB2 DB1 DB0 0 0 0 0 0 0 0 0 0

Fill DDRAM with "20H"(space code). And set DDRAM address counter (AC to"00H". Set entry mode I/D bit to be "1".

Cursor moves right and AC adds 1 after write or read operation.

#### • HOME

	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	0	0	0	0	0	0	0	0	1	Х

Set DDRAM address counter AC to "00H". Cursor moves to origin. Then content of DDRAM is not changed.

#### • ENTRY MODE SET

	RS								DB1	•
code	0	0	0	0	0	0	0	1	I/D	S

Set the cursor movement and display shift direction when doing write or read operation. I/D :address counter increase / decrease

When I/D = "1", cursor moves right, DRAM address counter AC add by 1. When I/D = "0", cursor moves left, DRAM address counter AC subtract by 1.

#### S: Display shift

S	I/D	DESCRIPTION
Н	Н	Entire display shift left by 1
Н	L	Entire display shift right by 1

#### DISPLAY STATUS

	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	0	0	0	0	0	0	1	D	С	В

#### Controls display, cursor and blink ON/OFF.

#### **D** : Display ON/OFF control bit

When D = "1", display ON

When D = "0", display OFF, the content of DDRAM is not changed

#### C : Cursor ON/OFF control bit

When C = "1", cursor ON.

When C = "0", cursor OFF.

#### **B** : Blink ON/OFF control bit

When B = "1", cursor position blink ON. Then display data in cursor position will blink. When B = "0", cursor position blink OFF



#### • CURSOR AND DISPLAY SHIFT CONTROL

code

RW DB7 DB6 DB5 DB4 DB3 DB2 RS DB1 DB0 0 S/C R/L 0 0 0 0 1 Х Х

#### Instruction to move the cursor or shift the entire display. The content of DDRAM is not changed.

S/C	R/L	Description	AC Value
L	L	Cursor moves left by 1	AC=AC-1
L	Н	Cursor moves right by 1	AC=AC+1
Н	L	Display shift left by 1, cursor also follows to shift.	AC=AC
Η	Н	Display shift right by 1, cursor also follows to shift.	AC=AC

#### FUNCTION SET

	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
code	0	0	0	0	1	DL	Х	RE	Х	X	

#### DL: 4/8 BIT interface control bit

When DL = "1", 8 BIT MPU bus interface

When DL = "0", **4 BIT** MPU bus interface

#### **RE** : extended instruction set control bit

- When RE = "1", extended instruction set
- When RE = "0", basic instruction set

In same instruction cannot alter DL and RE at once. Make sure that change DL first then RE.

#### • SET CGRAM ADDRESS

code

 RS
 RW
 DB7
 DB6
 DB5
 DB4
 DB3
 DB2
 DB1
 DB0

 0
 0
 0
 1
 AC5
 AC4
 AC3
 AC2
 AC1
 AC0

Set CGRAM address to address counter AC AC range is 00H..3FH

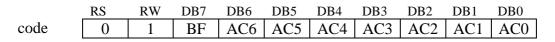
Make sure that in extended instruction SR=0 (scroll address or RAM address select)

#### SET DDRAM ADDRESS

Set DDRAM address to address counter (AC) . First line AC range is 80H..8FH Second line AC range is 90H..9FH Third line AC range is A0H..AFH Fourth line AC range is B0H..BFH Please note that only 2 lines can be display at a time.



#### READ BUSY FLAG (BF) AND ADDRESS



Read busy flag BF can check whether internal operation is finished. At the same time the value of address counter (AC) is also read. When BF = "1" new instruction will not be accepted. Must wait for BF = "0" for new instruction.

#### WRITE DATA TO RAM

	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	1	0	D7	D6	D5	D4	D3	D2	D1	D0

Write data to internal RAM and alter the (AC) by 1

Each RAM address (CGRAM,DDRAM,IRAM....) must write 2 consecutive bytes for 16 bit data. After the second byte the address counter will add or subtract by 1 according to the entry mode set control bit.

<b>READ RAM</b>	DAIA									
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	1	1	D7	D6	D5	D4	D3	D2	D1	D0

Read data from internal RAM and alter the (AC) by 1

After address set to read (CGRAM,DDRAM,IRAM.....)a DUMMY READ is required. There is no need to DUMMY READ for the following bytes unless a new address set instruction is issued.

#### Description of extended instruction set

STAND BY

	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	0	0	0	0	0	0	0	0	0	1

Instruction to enter standby mode. Any other instruction follows this instruction can terminate standby. The content of DDRAM remain the same.



			TALETAL							
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	0	0	0	0	0	0	0	0	1	SR

When SR = "1", the vertical scroll address set is enabled.

When SR = "0", the IRAM address set (extended instruction) and CGRAM address set(basic instruction) is enabled.

#### REVERSE

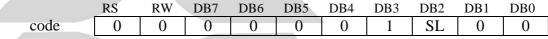
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	0	0	0	0	0	0	0	1	R1	R0

Select 1 out of 4 lines to reverse the display and to toggle the reverse condition by repeating this instruction.R1,R0 initial vale is 00. When set the first time the display is reversed and set the second time the display become normal.

<b>R1</b>	RO	Description
L	L	First line normal or reverse
L	Н	Second line normal or reverse
Η	L	Third line normal or reverse
Η	Η	Fourth line normal or reverse

Please note that only 2 lines out of 4 line display data can be displayed.

### • SLEEP



SL=1: leave sleep mode SL=0: enter sleep mode

#### **EXTENED FUNCTION SET**

	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	0	0	0	0	1	DL	X	RE	G	X

#### DL: 4/8 BIT interface control bit

When DL = "1", **8 BIT** MPU interface When DL = "0", **4 BIT** MPU interface

#### **RE** : extended instruction set control bit

When RE = "1", extended instruction set

When RE = "0", basic instruction set

#### G : Graphic display control bit

When G = "1", graphic display ON When G = "0", Graphic display OFF

In same instruction cannot alter DL, RE and G at once. Make sure that change DL or G first and then RE.



#### SET IRAM OR SCROLL ADDRESS

	RS	= = + +			DB5					•
code	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0

SR=1: AC5~AC0 is vertical scroll displacement address SR=0: AC3~AC0 is ICON RAM address

#### SET GRAPHIC RAM ADDRESS

	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
code	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0

Set GDRAM address to address counter AC .

First set vertical address and then horizontal address(write 2 consecutive bytes to complete vertical and horizontal address set)

Vertical address range is AC6...AC0

Horizontal address range is AC3...AC0

The address counter AC of graphic RAM(GRAM) only increment after write for horizontal address. After horizontal address=0FH it will automatically back to 00H. However, the vertical address will not increase as the result of the same action.

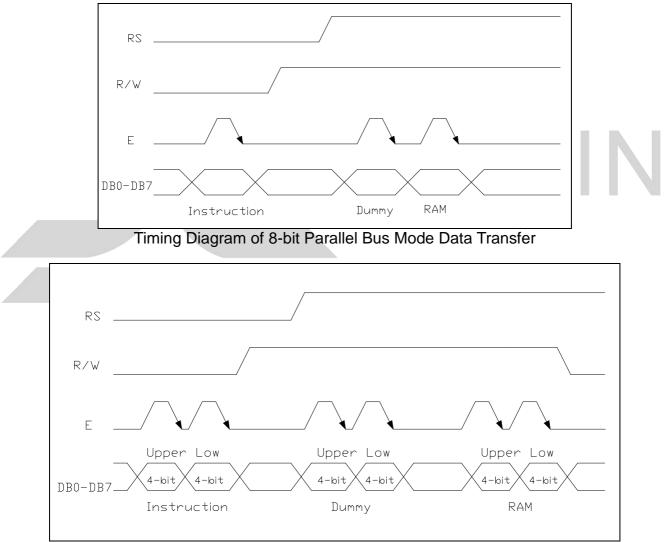


#### **Parallel interface**

ST7920 is in parallel mode by pulling up PSB pin. And can select 8 bit or 4-bit bus interface by function set instruction DL control bit. MPU can control ( RS , RW , E , and DB0..DB7 ) pins to complete the data transmission.

In 4-bit transfer mode, every 8 bits data or instruction is separated into 2 parts. Higher 4 bits DB7~DB4 data will transfer.

First and placed into data pins (DB7~DB4). Lower 4 bits (DB3~DB0) data will transfer second and placed into data pins (DB7~DB4). (DB3~DB0) data pins are not used.



Timing Diagram of 4-bit Parallel Bus Mode Data Transfer

#### Serial interface :

ST7920 is in serial interface mode when pull down PSB pin. Two pins (SCLK and SID) are used to complete the data transfer. Only write data is available.

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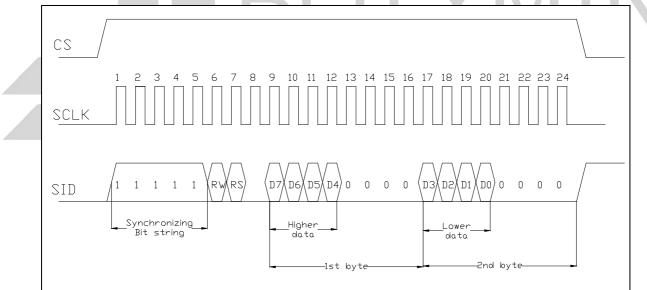
When connecting several ST7920, chip select (CS) must be used. Only when (CS) is high the serial clock (SCLK) can be accepted. On the other hand, when chip select (CS) is low ST7920 serial counter and data will be reset. Transmission will be terminated and data will be cleared. Serial transfer counter is set to the first bit. For a minimal system with only one ST7920 and one MPU,

only SCLK and SID pins are necessary. CS pin should pull to high.

ST7920's serial clock SCLK is asynchronous to the internal clock and is generated by MPU. When multiple instruction/data is transferred instruction execution time must be considered. Must wait for the previous instruction to finish before sending the next. ST7920 has no internal instruction buffer area.

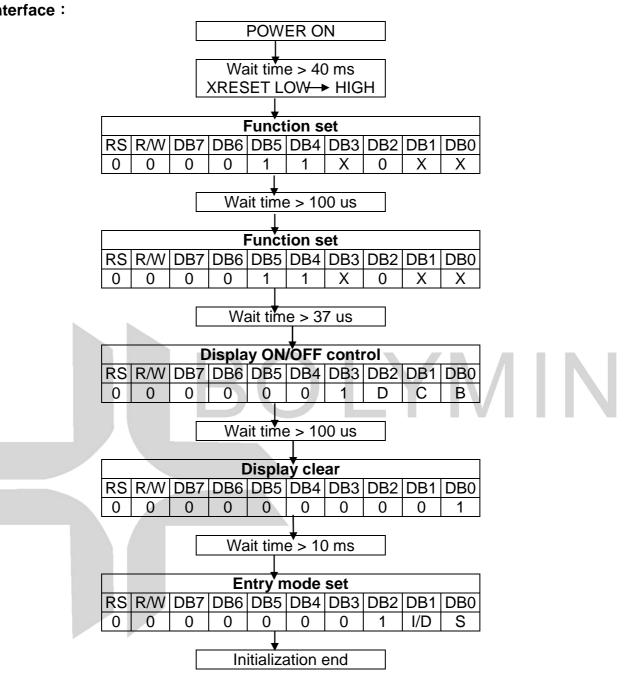
When starting a transmission a start byte is required. It consists of 5 consecutive "1"(sync character). Serial transfer counter will be reset and synchronized. Following 2 bits for read/write (RW) and register/data select (RS). Last 4 bits is filled by "0"

After receiving the sync character and RW and RS bits, every 8 bits instruction/data will be separated into 2 groups. Higher 4 bits (DB7~DB4) will be placed in first section followed by 4 "0". And lower 4 bits DB3~DB0 will be placed in second section followed by 4 "0".



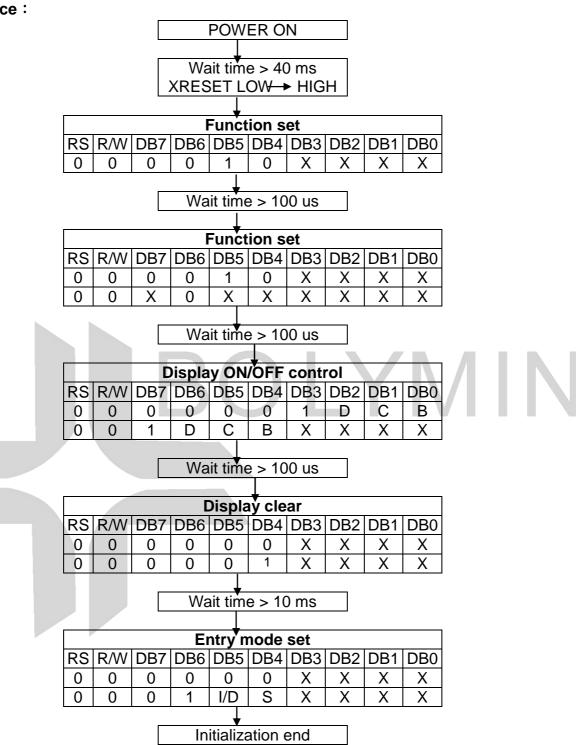
Timing Diagram of Serial Mode Data Transfer





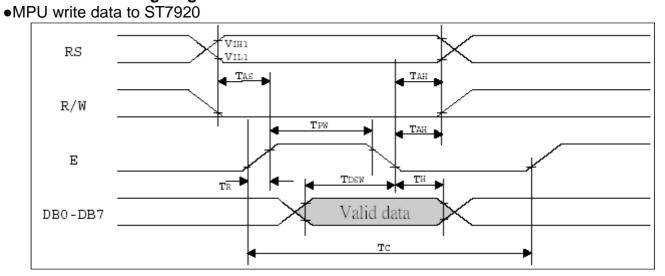
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4 bit interface :



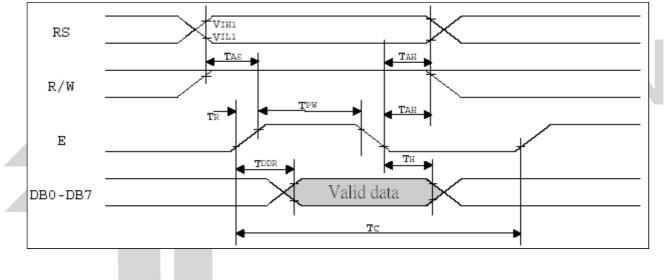
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### 8 bit interface timing diagram



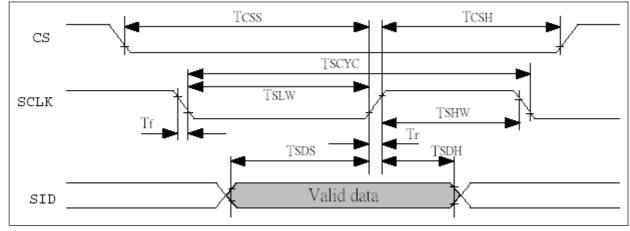
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#### • MPU read data from ST7920





# Serial interface timing diagram • MPU write data to ST7920



### DC Characteristics (TA=25°C, V DD=2.7V - 4.5V)

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Vdd	Operating Voltage	DAL	2.7	<u> </u>	5.5	V
VLCD	LCD Voltage	V0 – Vss	3.0	$  \forall  $	7	V
lcc	Power Supply Current	fosc = 530KHz, Vpd = 3.0V Rf = 18 kΩ	_	0.20	0.45	mA
VIH1	Input High Voltage (Except OSC1)	—	0.7 Vdd		Vdd	V
VIL1	Input Low Voltage (Except OSC1)	-	-0.3		0.6	V
Vih2	Input High Voltage (OSC1)	_	Vdd-1	_	Vdd	V
VIL2	Input Low Voltage (OSC1)	_	_		1.0	V
Vон1	Output High Voltage (DB0 – DB7)	Іон = -0.1 mA	0.8Vdd		Vdd	V
Vol1	Output Low Voltage (DB0 – DB7)	lo∟ = 0.1 mA	_		0.1	V
Vон2	Output High Voltage (Except DB0 – DB7)	Іон = -0.04 mA	0.8 Vdd	-	Vdd	V
Vol2	Output Low Voltage (Except DB0 – DB7)	IoL = 0.04 mA	-	-	0.1 Vdd	V
ILEAK	Input Leakage Current	VIN = 0V TO VDD	-1	_	1	μa
IPUP	Pull Up MOS Current	Vdd = 3V	22	27	32	μA

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Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Vdd	Operating Voltage	_	4.5	_	5.5	V
VLCD	LCD Voltage	V0 – Vss	3.0	_	7	V
lcc	Power Supply Current	$fosc = 540 \text{KHz}, \text{ V}_{\text{DD}} = 5 \text{ V}$ $\text{Rf} = 33 \text{k}\Omega$	_	0.45	0.75	mA
VIH1	Input High Voltage (Except OSC1)	_	0.7 Vdd		Vdd	V
VIL1	Input Low Voltage (Except OSC1)	—	-0.3	_	0.6	V
Vih2	Input High Voltage (OSC1)	—	Vdd-1	_	Vdd	V
VIL2	Input Low Voltage (OSC1)	—	-	_	1.0	V
Vон1	Output High Voltage (DB0 – DB7)	Іон = -0.1 mA	0.8Vdd		Vdd	V
Vol1	Output Low Voltage (DB0 – DB7)	lo∟ = 0.1 mA	_	—	0.4	V
Vон2	Output High Voltage (Except DB0 – DB7)	Іон = -0.04 mA	0.8 Vdd	-/	Vdd	V
Vol2	Output Low Voltage (Except DB0 – DB7)	10L = 0.04 mA	_		0.1 Vdd	V
ILEAK	Input Leakage Current	VIN = 0V TO VDD	-1	_	1	μA
IPUP	Pull Up MOS Current	Vdd = 5 V	75	80	85	μA

AC Characteristics	$(T_A = 25^{\circ}C, V_{DD} = 4.5V)$	) Parallel Mode Interface
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Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
		Internal Clock Operation	1		•	
fosc	LCD Voltage	V0-Vss	3.0	_	7	V
fex	Power Supply Current	$fosc = 540 \text{KHz}, \text{ Vdd} = 5 \text{ V}$ $\text{Rf} = 33 \text{k}\Omega$	_	0.45	0.75	mA
VIH1	Input High Voltage (Except OSC1)	_	0.7 Vdd	_	Vdd	V
VIL1	Input Low Voltage (Except OSC1)	_	-0.3		0.6	V
VIH2	Input High Voltage (OSC1)	_	Vdd-1		Vdd	V
VIL2	Input Low Voltage (OSC1)	—	-	_	1.0	V
Vон1	Output High Voltage (DB0 – DB7)	Іон = -0.1 mA	0.8Vdd		Vdd	V
Vol1	Output Low Voltage (DB0 – DB7)	lo∟ = 0.1 mA	_	_	0.4	V
Vон2	Output High Voltage (Except DB0 – DB7)	Iон = -0.04 mA	0.8 Vdd	-/	Vdd	V
Vol2	Output Low Voltage (Except DB0 – DB7)	loL = 0.04 mA	_		0.1 Vdd	V
ILEAK	Input Leakage Current	VIN = 0V TO VDD	-1	_	1	μA
IPUP	Pull Up MOS Current	Vdd = 5 V	75	80	85	μA

Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
		Internal Clock Operation				
fosc	OSC Frequency	R=33kΩ	480	540	600	KHz
		External Clock Operation				
f <sub>EX</sub>	External Frequency	_	480	540	600	KHz
	Duty Cycle	_	45	50	55	%
Tr,Tf	Rise/Fall Time	_	_	_	0.2	μS
	Write Mo	ode (Writing data from MPU to	ST7920	)		
Tc	Enable Cycle Time	Pin E	1200		_	nS
TPW	Enable Pulse Width	Pin E	140	_	—	nS
Tr,Tf	Enable Rise/Fall Time	Pin E	_	—	25	nS
Tas	Address Setup Time	Pins : RS,RW,E	10	_	_	_nS`
Тан	Address Hold Time	Pins : RS,RW,E	20	$\Lambda - /$	-	nS
Tosw	Data Setup Time	Pins : DB0-DB7	40		-	nS
Тн	Data Hold Time	Pins : DB0-DB7	20			nS
	Read Mo	de (Reading Data from ST792	20 to MP	J)		
Тс	Enable Cycle Time	Pin : E	1200	—	—	nS
Tpw	Enable Pulse Width	Pin : E	140	_	_	nS
Tr,Tf	Enable Rise/Fall Time	Pin : E	_	_	25	nS
Tas	Address Setup Time	Pins : RS,RW,E	10	_	—	nS
Тан	Address Hold Time	Pins : RS,RW,E	20	_	—	nS
Tddr	Data Delay Time	Pins : DB0-DB7		_	100	nS
Тн	Data Hold Time	Pins : DB0-DB7	20	—	—	nS
	Interf	ace Mode with LCD Driver (ST	Г7921)			
Тсwн	Clock Pulse with High	Pins : CL1, CL2	800	_	_	nS
Tcw∟	Clock Pulse With Low	Pins : CL1, CL2	800	_	_	nS
Тсѕт	Clock Setup time	Pins : CL1, CL2	500	_	—	nS
Ts∪	Data Setup Time	Pin : D	300		—	nS
Том	Data Hold Time	Pin : D	300		_	nS
TPW	Enable Pulse Width	Pin : M	-1000		1000	nS



Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Uni
		Internal Clock Operation			. 1	
fosc	OSC Frequency	R=18kΩ	470	530	590	KHz
	· · ·	External Clock Operation				
fex	External Frequency	_	470	530	590	KH:
	Duty Cycle	_	45	50	55	%
Tr,Tf	Rise/Fall Time	_	—	_	0.2	μS
	Write Mc	de (Writing data from MPU	to ST7920	))		
Тс	Enable Cycle Time	Pin E	1800	—	—	nS
TPW	Enable Pulse Width	Pin E	160	_	—	nS
Tr,Tf	Enable Rise/Fall Time	Pin E	-	_	25	nS
Tas	Address Setup Time	Pins : RS,RW,E	10	<b> </b> \-/	_	nS
Тан	Address Hold Time	Pins : RS,RW,E	20	V	_	nS
Tosw	Data Setup Time	Pins : DB0-DB7	40	—	—	nS
Тн	Data Hold Time	Pins : DB0-DB7	20			nS
	Read Moo	de (Reading Data from ST7	20 to MP	U)		
Тс	Enable Cycle Time	Pin : E	1800	_	_	nS
TPW	Enable Pulse Width	Pin : E	320	_	—	nS
Tr,Tf	Enable Rise/Fall Time	Pin : E		_	25	nS
Tas	Address Setup Time	Pins : RS,RW,E	10	_	—	nS
Тан	Address Hold Time	Pins : RS,RW,E	20	_	—	nS
Tddr	Data Delay Time	Pins : DB0-DB7	-	_	260	nS
Тн	Data Hold Time	Pins : DB0-DB7	20	—	—	nS
		ace Mode with LCD Driver (	ST7921)	I		
Тсwн	Clock Pulse with High	Pins : CL1, CL2	800	_	_	nS
TcwL	Clock Pulse With Low	Pins : CL1, CL2	800	_	_	nS
Тсѕт	Clock Setup time	Pins : CL1, CL2	500			nS
Ts∪	Data Setup Time	Pin : D	300			nS
Том	Data Hold Time	Pin : D	300	_	_	nS
TPW	Enable Pulse Width	Pin : M	-1000	-	1000	nS

AC Characteristics ( $T_A = 25$ °C,  $V_{DD} = 2.7V$ ) Parallel Mode Interface